

Docket No.: 42478-6200

RESPONSE UNDER 37 CFR SECTION 1.116  
EXPEDITED PROCEDURE - GROUP 2857**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:

Ejii Takahashi et al.

Serial No.: 10/029,571

Filed: December 20, 2001

For: MULTILAYER BOARD IN WHICH  
WIRING OF SIGNAL LINE THAT  
REQUIRES TAMPER-RESISTANCE  
IS COVERED BY COMPONENT OR  
FOIL, DESIGN APPARATUS,  
METHOD, AND PROGRAM FOR  
THE MULTILAYER BOARD, AND  
MEDIUM RECORDING THE  
PROGRAM

Patent Examiner: Tsai, Carol S.W.

Group Art Unit: 2857

September 15, 2004

Irvine, California 92614

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**RULE 1.116 AMENDMENT AFTER FINAL OFFICE ACTION**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sirs:

In response to the Office Action of June 15, 2004, please amend the above-identified  
application as follows: